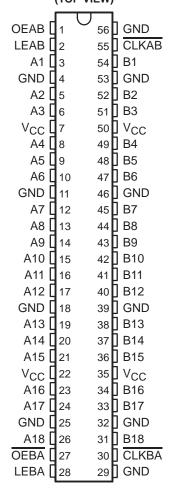
- Members of the Texas Instruments Widebus™ Family
- B-Port Outputs Have Equivalent 25- Ω Series Resistors, So No External Resistors Are Required
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- UBT™ (Universal Bus Transceiver)
 Combines D-Type Latches and D-Type
 Flip-Flops for Operation in Transparent,
 Latched, or Clocked Mode
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes. Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs.

SN54ABT162500 ... WD PACKAGE SN74ABT162500 ... DL PACKAGE (TOP VIEW)



For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the high-to-low transition of CLKAB. Output-enable OEAB is active high. When OEAB is high, the outputs are active. When OEAB is low, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses $\overline{\text{OEBA}}$, LEBA, and $\overline{\text{CLKBA}}$. The output enables are complementary (OEAB is active high and $\overline{\text{OEBA}}$ is active low).

The B-port outputs, which are designed to source or sink up to 12 mA, include equivalent 25- Ω series resistors to reduce overshoot and undershoot.



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SN54ABT162500, SN74ABT162500 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor and OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

The SN54ABT162500 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT162500 is characterized for operation from –40°C to 85°C.

FUNCTION TABLET

	OUTPUT			
OEAB	LEAB	CLKAB	Α	В
L	Х	Х	Х	Z
Н	Н	Χ	L	L
Н	Н	Χ	Н	Н
Н	L	\downarrow	L	L
Н	L	\downarrow	Н	Н
Н	L	Н	Χ	в ₀ ‡ в ₀ §
Н	L	L	Χ	в ₀ §

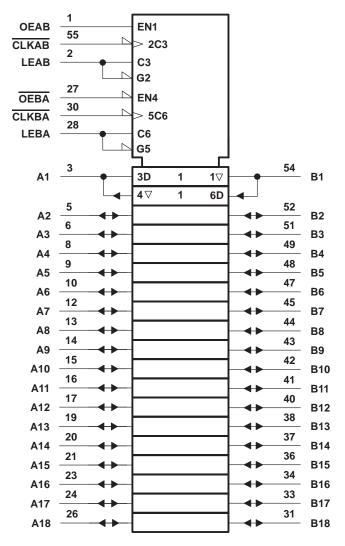
[†] A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.



[‡] Output level before the indicated steady-state input conditions were established

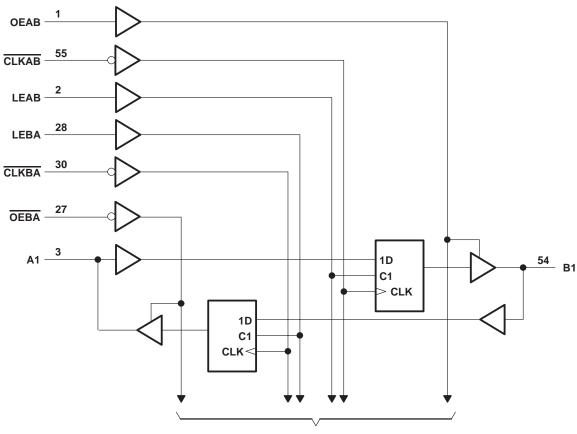
[§] Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To 17 Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT162500 (A port)	96 mA
SN74ABT162500 (A port)	128 mA
B port	30 mA
Input clamp current, $I_{ K }(V_{ I } < 0)$	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): DL package	74°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



recommended operating conditions (see Note 3)

			SN54ABT	162500	SN74ABT	162500	UNIT	
			MIN	MAX	MIN	MAX	UNIT	
VCC	Supply voltage	4.5	5.5	4.5	5.5	V		
VIH	High-level input voltage		2		2		V	
V _{IL}	Low-level input voltage		0.8		0.8	V		
VI	Input voltage	0	Vcc	0	VCC	V		
lau	High lovel output current	A port	4	-24	-32		mA	
ЮН	High-level output current	B port	<i>.</i>	-12		-12	""	
la.	Low-level output current	A port	22	48		64	mA	
lOL	Low-level output current	B port	000	12		12	IIIA	
Δt/Δν	Input transition rise or fall rate	Outputs enabled	Q	10		10	ns/V	
Δt/ΔVCC	Power-up ramp rate	200		200		μs/V		
TA	Operating free-air temperature	-55	125	-40	85	°C		

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAMETER	TEAT 001	UDITIONS	Т	A = 25°C	;	SN54ABT	162500	SN74ABT	162500	LINUT	
PA	RAMETER	TEST COI	NULLIONS	MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNIT	
٧ıĸ		$V_{CC} = 4.5 \text{ V}, \qquad I_{I} = -18 \text{ mA}$				-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	I _{OH} = -3 mA	2.5			2.5		2.5			
	A port	$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3		3			
	A port	V 45V	I _{OH} = -24 mA	2			2					
\ \/ -		V _{CC} = 4.5 V	I _{OH} = -32 mA	2*					2		V	
VOH		V _{CC} = 4.5 V,	$I_{OH} = -1 \text{ mA}$	3.35			3.3		3.35		V	
	B port	V _{CC} = 5 V,	I _{OH} = -1 mA	3.85			3.8		3.85			
	D port	V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	3.1			3		3.1			
		VCC = 4.5 V	I _{OH} = -12 mA	2.6					2.6			
	A port	V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55		0.55				
VOL	A port	VCC = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	V	
	B port	$V_{CC} = 4.5 \text{ V},$	I _{OL} = 12 mA			0.8		0.8		8.0		
V _{hys}					100						mV	
			$C = 0$ to 5.5 V, $V_I = V_{CC}$ or GND			±1		±1		±1		
Ιι	A or B ports	$V_{CC} = 2.1 \text{ V to } 5.5$ $V_{I} = V_{CC} \text{ or GND}$			±20		±20		±20	μΑ		
lozpu	J	$V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} \text{ or } OE = X$				±50	500	±50		±50	μА	
IOZPE)	$V_{CC} = 2.1 \text{ V to } 0,$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} \text{ or } OE = X$ §				±50	Pho	±50		±50	μА	
lozH [‡]	:	$V_{CC} = 2.1 \text{ V to } 5.5$ $V_{O} = 2.7 \text{ V, } \overline{OE} \ge 2$	V, V or OE ≤ 0.8 V			10		10		10	μА	
lozL‡		$V_{CC} = 2.1 \text{ V to } 5.5$ $V_{O} = 0.5 \text{ V}, \overline{OE} \ge 2$	V , V or $OE \le 0.8 V$			-10		-10		-10	μА	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ	
ICEX		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μА	
	A port	., 55,4		-50	-110	-180	-50	-180	-50	-180		
IO¶	B port	V _{CC} = 5.5 V,	$V_0 = 2.5 \text{ V}$	-25	-55	-90	-25	-90	-25	-90	mA	
		V _{CC} = 5.5 V,	Outputs high			3		3		3		
Icc	A or B ports	$I_{O} = 0$,	Outputs low			36		36		36	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			3		3		3		
∆l _{CC} #	$V_{CC} = 5.5 \text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND				50		50		50	μА		
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3						pF	
Cio	A or B ports	V _O = 2.5 V or 0.5 \	/		9						pF	
	ducte compliant t		-				-					

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] The parameters IOZH and IOZL include the input leakage current.

[§] For V_{CC} between 2.1 V and 4 V, OE should be less than or equal to 0.5 V to ensure a low state.

[¶] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[#]This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

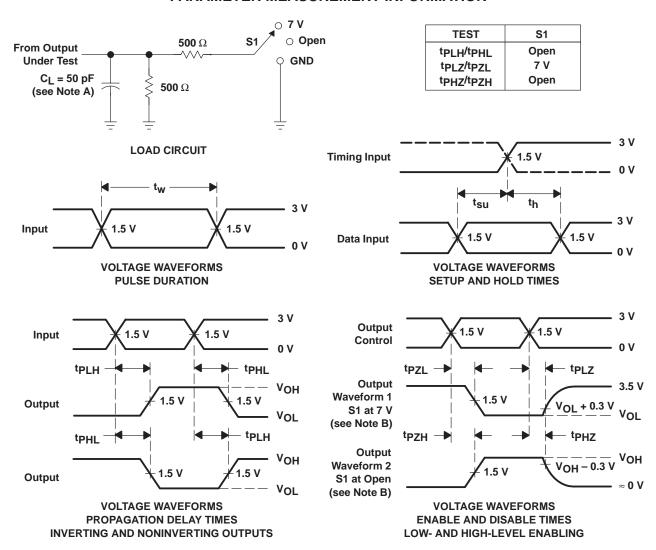
timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

				SN54ABT	162500	SN74ABT	162500	UNIT
				MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency			150		150	MHz	
t Pulse duration		LEAB or LEBA high		2.5	3	2.5		no
t _W	Pulse duration	CLKAB or CLKBA high or low	3	77	3		ns	
		A before CLKAB↓	3.3	27	3.3			
١.	Catura tima	B before CLKBA↓	3.3	ζ	3.3			
t _{su}	Setup time	A before LEAB↓ or B before LEBA↓	CLK high	3		1		ns
		A before LEAB\$\(\pi\) of B before LEBA\$\(\pi\)	CLK low	2.5		2.5		
.	Hold time	A after CLKAB↓ or B after CLKBA↓	A after CLKAB↓ or B after CLKBA↓			0		ne
t _h	HOIG LITTE	A after LEAB↓ or B after LEBA↓	2		2		ns	

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C			SN54ABT	162500	SN74ABT	UNIT	
	(IIVI O1)	(0011 01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f _{max}			150	200		150		150		MHz
^t PLH	A or B	B or A	1.5	2.6	4	1.5	5.1	1.5	4.8	ne
t _{PHL}	AOIB	BOLA	2	3.4	5.2	2	6.1	2	5.7	ns
^t PLH	LEAB or LEBA	B or A	2	3.3	4.8	2	6.1	2	5.6	ns
^t PHL	LEAD OF LEBA	BULA	2	3.8	5.2	2 2	6.4	2	5.9	115
^t PLH	<u> </u>	B or A	1.5	3.7	4.9	1.5	6.4	1.5	5.9	ns
^t PHL	CLKAB or CLKBA	B OF A	1.5	3.8	5.2	1.5	6.4	1.5	6	115
^t PZH	054B 05B4	B or A	1.5	3.4	4.6	1.5	5.6	1.5	5.3	ns
tpZL	OEAB or OEBA	BULA	2	3.8	4.7	2	5.6	2	5.4	115
^t PHZ	OFAR as OFRA	B or A	2	4.5	5.7	2	6.9	2	6.5	ne
t _{PLZ}	OEAB or OEBA	DULA	1.5	3.8	5.3	1.5	6.3	1.5	5.8	ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ABT162500DLRG4	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT162500DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT162500DLG4	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT162500DLR	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

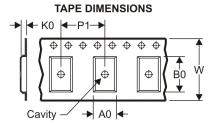
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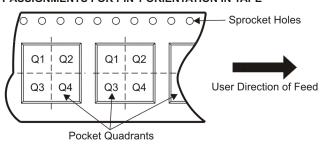
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT162500DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT162500DLR	SSOP	DL	56	1000	346.0	346.0	49.0

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